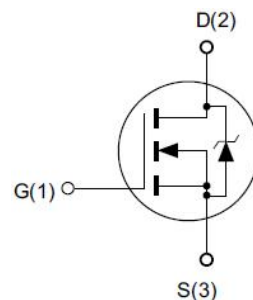
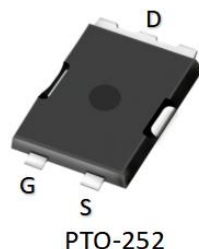


Features

- ◆ 650V, 10A, $R_{DS(ON)}(Typ.) = 0.80\Omega @ V_{GS} = 10V$.
- ◆ Low C_{rss}
- ◆ Fast Switching
- ◆ 100% Avalanche Tested

Application

- ◆ Adapter
- ◆ LCD/PDP Adapter
- ◆ E-Bike Charger



Absolute Maximum Ratings $T_c = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage ^a	650	V
V_{GS}	Gate-Source Voltage	± 30	V
I_D	Drain Current-Continuous, $T_C = 25^\circ\text{C}$	10	A
	Drain Current-Continuous, $T_C = 100^\circ\text{C}$	6.8	A
I_{DM}	Drain Current-Pulsed ^b	40	A
P_D	Maximum Power Dissipation @ $T_J = 25^\circ\text{C}$	100	W
E_{AS}	Single Pulsed Avalanche Energy ^d	845	mJ
T_J, T_{STG}	Operating and Store Temperature Range	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-Case Max.	1.25	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance Junction-Ambient Max.	62.5	$^\circ\text{C/W}$

Electrical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

Off Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	650	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650V, V_{GS} = 0V$	-	-	1	μA
I_{GSS}	Forward Gate Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 30V$	-	-	± 100	nA

■ On Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	2	-	4	V
$R_{DS(on)}$	Static Drain-Source On-Resistance ^c	$V_{GS} = 10V, I_D = 5A$	-	0.80	1.00	Ω

■ Dynamic Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Ciss	Input Capacitance	$V_{DS} = 25V,$ $V_{GS} = 0V,$ $f = 1.0MHz$	-	1595	-	pF
Coss	Output Capacitance		-	134	-	pF
Crss	Reverse Transfer Capacitance		-	6.6	-	pF

■ On Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 325V, I_D = 10A,$ $R_G = 25\Omega, V_{GS} = 10V$	-	25	-	ns
t_r	Turn-On Rise Time		-	21	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	50	-	ns
t_f	Turn-Off Fall Time		-	23	-	ns
Qg	Total Gate Charge	$V_{DS} = 325V, I_D = 10A,$ $V_{GS} = 10V$	-	31.9	-	nC
Qgs	Gate-Source Charge		-	8.1	-	nC
Qgd	Gate-Drain Charge		-	11.9	-	nC

■ Drain-Source Diode Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
I_S	Drain-Source Diode Forward Continuous Current	$V_{GS} = 0V$	-	-	10	A
I_{SM}	Maximum Pulsed Current	$V_{GS} = 0V$	-	-	40	A
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0V, I_S = 10A$	-	-	1.4	V
T_{rr}	Body Diode Reverse Recovery Time	$di/dt = 100A/\mu s$ $I_S = 10A, V_{GS} = 0V$	-	498	-	ns
Qrr	Reverse Recovery Charge		-	3.0	-	μC

Notes:

- $T_J = +25^\circ C$ to $+150^\circ C$
- Repetitive rating; pulse width limited by maximum junction temperature.
- Pulse width $\leq 300\mu s$; duty cycle $\leq 2\%$
- $L = 10mH, V_{DD} = 50V, I_{AS} = 9A, R_G = 25\Omega$ Starting $T_J = 25^\circ C$

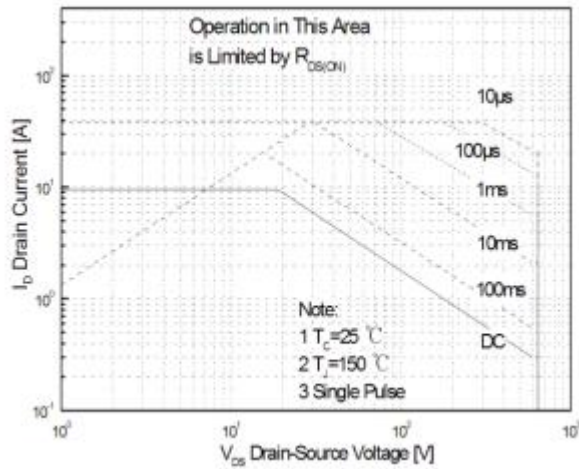


Figure1. Maximum Safe Operating Area

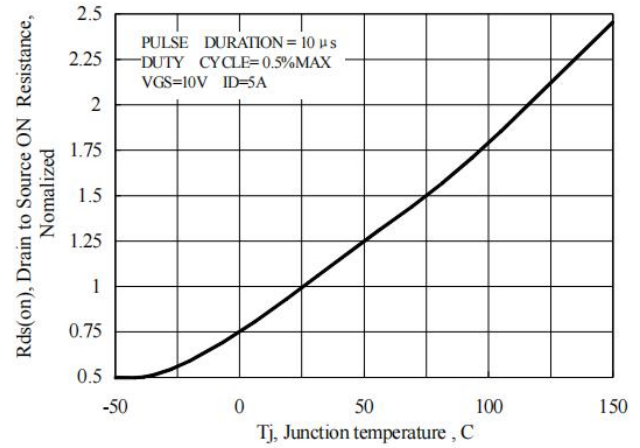


Figure2. Normalized On-Resistance Variation with Temperature

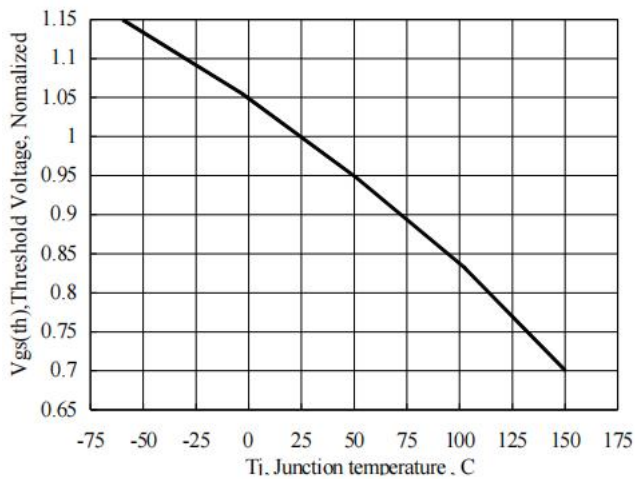


Figure 3. Gate Threshold Variation with Temperature

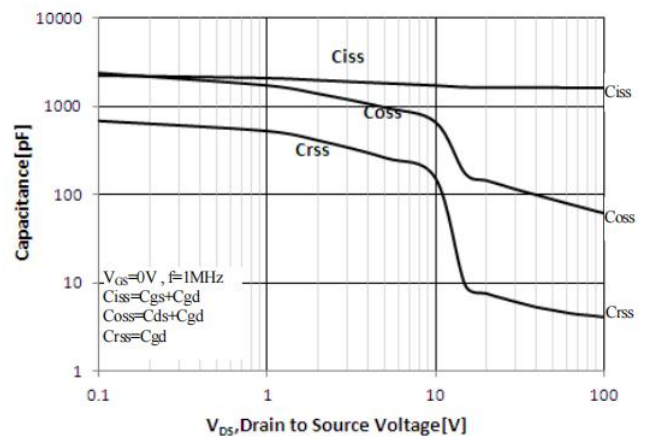


Figure 4. Capacitance Characteristics

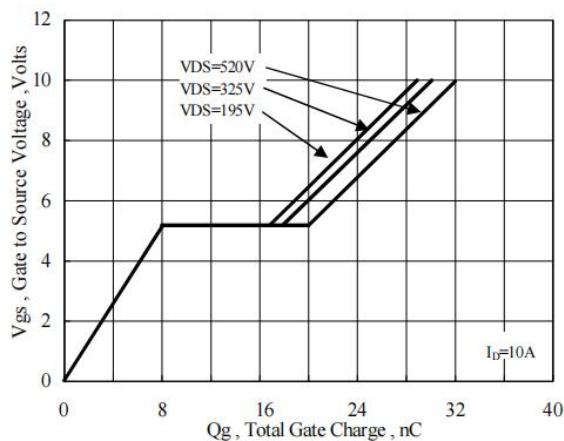


Figure 5. Gate Charge Characteristics

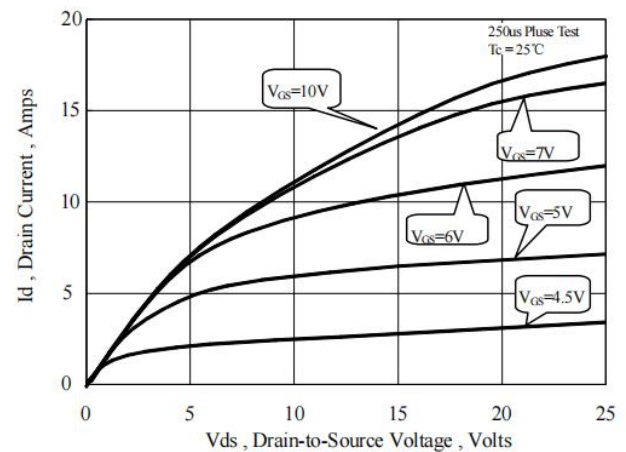


Figure 6. On-State Characteristics

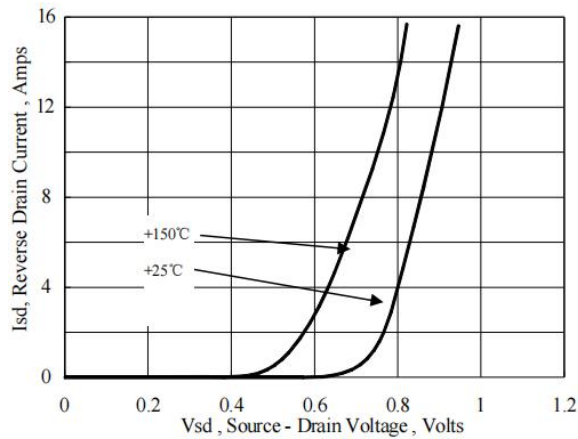


Figure 7. Body Diode Forward Voltage Variation with Source Current

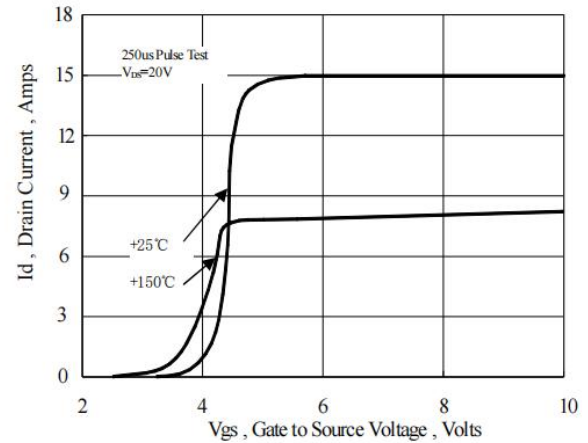


Figure 8. Transfer Characteristics Variation with Source Current

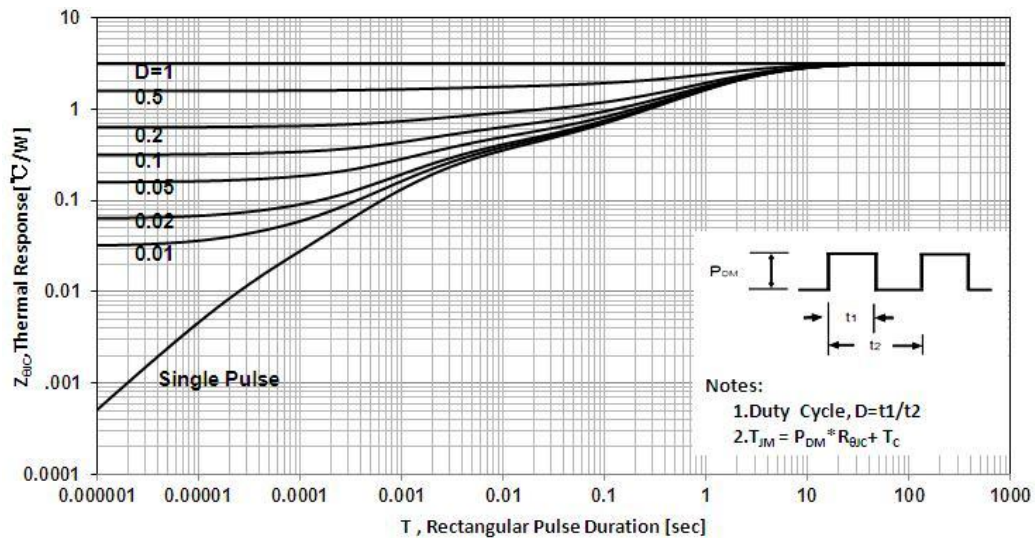
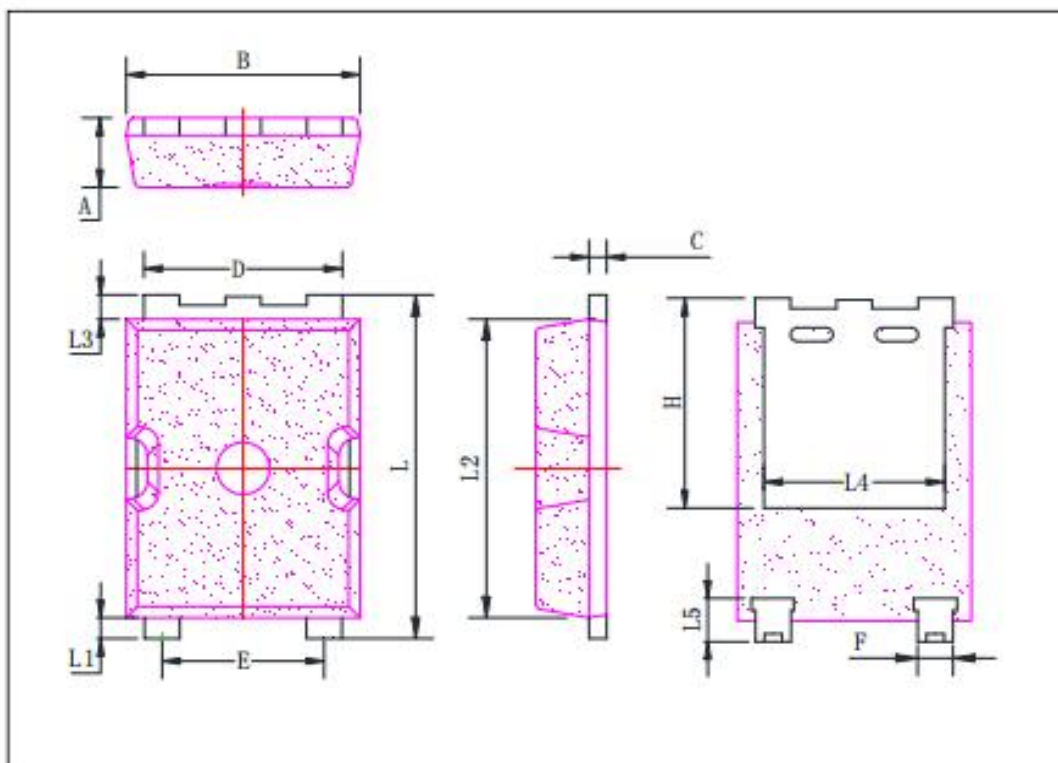


Figure 9. Maximum Effective Thermal Impedance , Junction to Case

■ Package Information



Symbol	Min	Typ	Max
A	1.90	2.00	2.10
B	6.50	6.60	6.70
C	0.45	0.50	0.60
D	5.50	5.60	5.70
E	4.50	4.60	4.70
F	0.90	1.00	1.05
H	5.90	6.05	6.20
L	9.80	9.90	10.0
L1	0.50	0.60	0.70
L2	8.50	8.60	8.70
L3	0.60	0.70	0.80
L4	4.65	4.80	4.90
L5	1.10	1.25	1.40